

# Z0409MB

## Datasheet

## 4 A - Triac in DPAK package



DPAK

### **Features**

- 4 A Triac
- $V_{DRM}$  /  $V_{RRM}$  = 600 V and  $V_{DSM}$  /  $V_{RSM}$  = 750 V
- 125 °C maximum junction temperature T<sub>i</sub>
- DPAK package
- 4 quadrants triacs with I<sub>GT</sub> = 10 mA
- Halogen-free molding, lead-free plating
- ECOPACK2 compliant

### **Applications**

- Actuators
- Heating elements
- Inrush current limiting circuits

### **Description**

The Z0409MB series is 4 A Triac housed in compact SMD DPAK. This 4 quadrants device is suited to home appliances or power tools and industrial systems and drives loads up to 4 A.

Product s	Product status link			
Z040	Z0409MB			
Product summary				
I <sub>T(RMS)</sub>	4 A			
V <sub>DSM</sub> /V <sub>RSM</sub>	750 V			
I <sub>GT</sub>	10 mA			
T <sub>j</sub> max.	125 °C			

## 1 Characteristics

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Symbol	Parameter	Value	Unit	
I <sub>T(RMS)</sub>	RMS on-state current (full sine wave) $T_c = 107 \text{ °C}$		4	А
<b>I</b>	Non repetitive surge peak on-state current (full cycle,	t = 16.7 ms	16	А
I <sub>TSM</sub>	T <sub>j</sub> initial = 25 °C)	t = 20 ms	15	A
l <sup>2</sup> t	I <sup>2</sup> t value for fusing	t <sub>p</sub> = 10 ms	1.5	A <sup>2</sup> s
dl/dt	Critical rate of rise of on-state current, $I_G = 2 \times I_{GT}$ , tr $\leq 100$ ns, f = 120 Hz		50	A/µs
V <sub>DRM</sub> /V <sub>RRM</sub>	Repetitive peak off-state voltage $T_j = 125 \ ^{\circ}C$		600	V
V <sub>DSM</sub> /V <sub>RSM</sub>	Non Repetitive peak off-state voltage, 10 ms	750	V	
I <sub>GM</sub>	Maximum peak gate current		1.2	А
P <sub>GM</sub>	$t_p = 20 \ \mu s, \ T_j = 125 \ ^\circ C$		0.5	W
T <sub>stg</sub>	Storage temperature range	-40 to +125	°C	
Тј	Operating junction temperature range	-40 to +125	°C	
ΤL	Maximum lead temperature for soldering during 10 s	260	°C	

### Table 1. Absolute maximum ratings (limiting values)

## Table 2. Electrical characteristics (T<sub>j</sub> = 25 °C, unless otherwise specified)

Symbol	Test conditions	Value	Unit		
I <sub>GT</sub> <sup>(1)</sup>	$V_D = 12 \text{ V}, \text{ R}_L = 33 \Omega$		Max.	10	mA
V <sub>GT</sub>	V <sub>D</sub> = 12 V, R <sub>L</sub> = 33 Ω		Max.	1.3	V
V <sub>GD</sub>	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega \qquad \qquad T_j = 125 \text{ °C}$		Min.	0.2	V
$I_L$ $I_G = 1.2 \times I_{GT}$	$l_0 = 1.2 \times l_{0.7}$	I-III-IV	Max.	15	mA
		II	Max.	25	mA
I <sub>H</sub> <sup>(2)</sup>	I <sub>T</sub> = 500 mA, gate open		Max.	10	mA
dV/dt (2)	$V_D$ = 67 % $V_{DRM}$ ; $V_R$ = 67 % $V_{RRM}$ , gate open $T_j$ = 110 °C		Min.	100	V/µs
(dV/dt)c (2)	$(dl/dt)c = 1.8 \text{ A/ms}$ $T_i = 110 \text{ °C}$		Min.	2	V/µs

1. For both polarities of OUT pin referenced to COM pin.

2. For both polarities of A2 referenced to A1.

### Table 3. Static characteristics

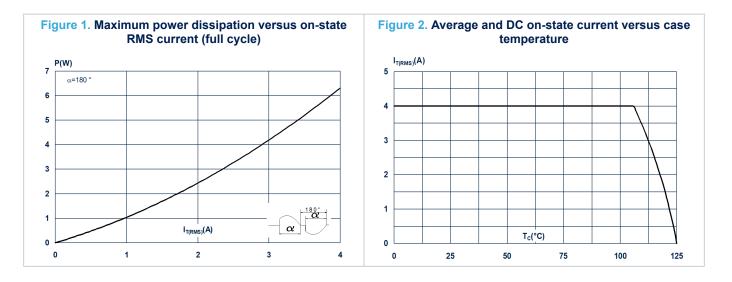
Symbol	Test conditions	Тj		Value	Unit
V <sub>TM</sub> <sup>(1)</sup>	I <sub>TM</sub> = 5.5 A, t <sub>p</sub> = 380 μs	25 °C	Max.	2	V
V <sub>TO</sub> <sup>(1)</sup>	Threshold voltage	125 °C	Max.	0.95	V
R <sub>D</sub> <sup>(1)</sup>	Dynamic resistance	125 °C	Max.	180	mΩ
I <sub>DRM</sub> /I <sub>RRM</sub>	$V_D = V_R = V_{DRM} = V_{RRM}$	25 °C	Max.	5	μA
'URM' 'RRM		125°C		0.5	mA

1. For both polarities of A2 referenced to A1.

### Table 4. Thermal resistance

Symbol	Parameter	Value	Unit	
R <sub>th(j-c)</sub>	Junction to case (AC)	Max.	3	°C/W
R <sub>th(j-a)</sub>	Junction to ambient: $S_{CU}$ = 0.5 cm <sup>2</sup>	Тур.	70	°C/W

## 1.1 Characteristics (curves)



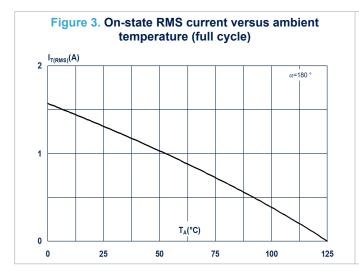


Figure 4. Relative variation of thermal impedance versus pulse duration K=[Zth/Rth] 1.E+00 Zth Ztł 1.E-01 t<sub>P</sub>(s) 1.E-02 1.E-03 1.E-02 1.E-01 1.E+00 1.E+01 1.E+02 1.E+03

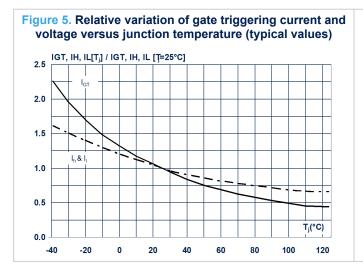
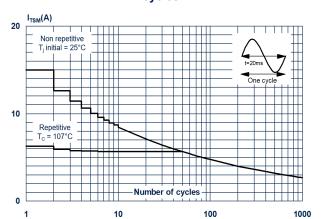
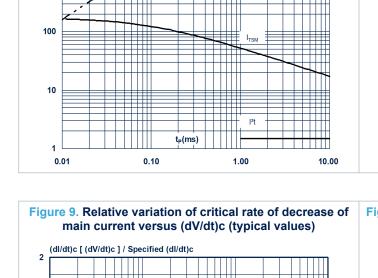


Figure 6. Surge peak on-state current versus number of cycles





value of l<sup>2</sup>t

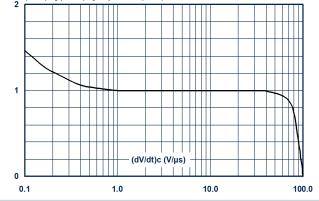
T, initial=25 °C

dl/dt limitation : 50A/us

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I<sub>TSM</sub>(A)

1000



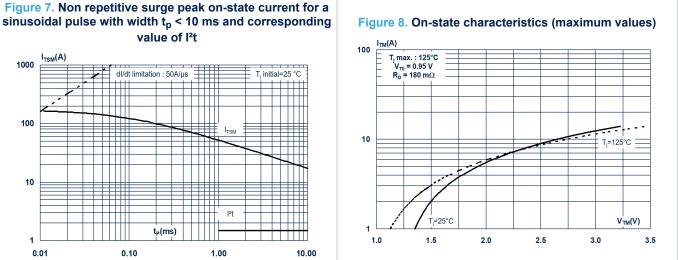
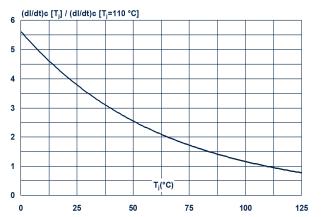
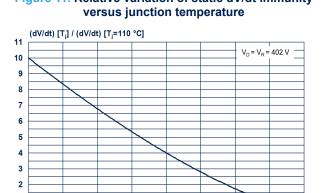


Figure 10. Relative variation of critical rate of decrease of main current versus junction temperature





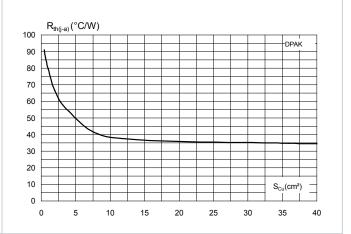
T<sub>j</sub>(°C)

75

125

100

Figure 12. Thermal resistance junction to ambient versus copper surface under tab (typical values)





1

0

25

50

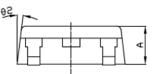
## 2 Package information

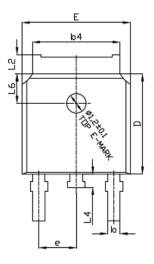
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

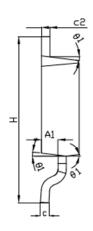
### 2.1 DPAK package information

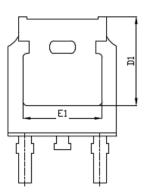
- Molding compouned resin is halogen free and meets UL94 flammability standard, level V0
- Lead-free package leads plating

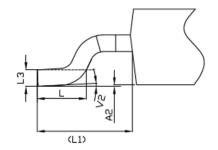
### Figure 13. DPAK package outline











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I

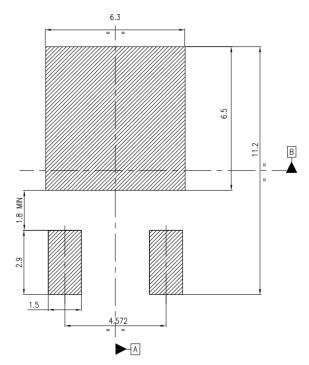
	Dimensions					
Ref.		Millimeters		Inches <sup>(1)</sup>		
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	2.20	2.30	2.38	0.0866	0.0906	0.0937
A1	0.90	1.01	1.10	0.0354	0.0398	0.0433
A2	0.00		0.10	0.0000		0.0039
b	0.72		0.85	0.0283		0.335
b4	5.13	5.33	5.46	0.2020	0.2098	0.2150
С	0.47		0.60	0.0185		0.0236
c2	0.47		0.60	0.0185		0.0236
D	6.00	6.10	6.20	0.2362	0.2402	0.2441
D1	5.15	5.40	5.65	0.2028	0.2126	0.2224
Е	6.50	6.60	6.70	0.2550	0.2598	0.2638
E1	4.70	4.85	5.00	0.1850	0.1909	0.1969
е	2.186	2.286	2.386	0.0860	0.0900	0.0940
Н	9.80	10.10	10.40	0.3858	0.3976	0.4094
L	1.40	1.50	1.70	0.0551	0.0591	0.0669
L1		2.90 REF			0.1142 REF	
L2	0.90		1.25	0.0354		0.0492
L3		0.51 BSC			0.201 BSC	
L4	0.60	0.80	1.00	0.0236	0.0315	0.0394
L6	1.80 BSC				0.0709 BSC	
θ1	5°	7°	9°	5°	7°	9°
θ2	5°	7°	9°	5°	7°	9°
V2	0°		8°	0°		8°

### Table 5. DPAK package mechanical data

1. Dimensions in inches are given for reference only

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Note:

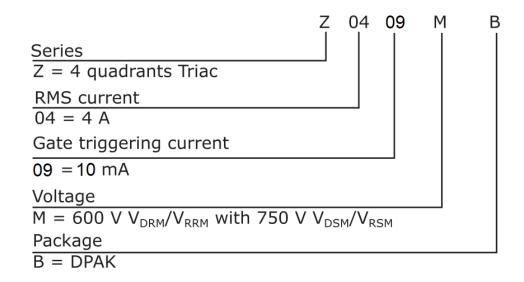


### Figure 14. DPAK recommended footprint (dimensions are in mm)

## **3** Ordering information

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### Figure 15. Ordering information scheme



#### Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
Z0409MB	Z0409MB	DPAK	0.3 g	2500	Tape and reel

# **Revision history**

### Table 7. Document revision history

Date	Revision	Changes
05-Sep-2022	1	Initial release.

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